
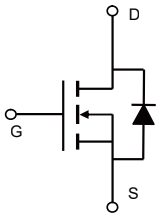


<p>Description</p> <p>These N-Channel enhancement mode power field effect transistors are using shielded gate trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.</p> <p>Features</p> <ul style="list-style-type: none"> ◆ 100V, 140A, $R_{DS(on),max}=4.7m\Omega@V_{GS} = 10V$ ◆ Improved dv/dt capability ◆ Fast switching ◆ 100% EAS Guaranteed ◆ Green device available <p>Applications</p> <ul style="list-style-type: none"> ◆ Motor Drives ◆ UPS ◆ DC-DC Converter 	<p>Product Summary</p> <table border="0"> <tr> <td>V_{DSS}</td> <td>100V</td> </tr> <tr> <td>$R_{DS(on),max}@V_{GS}=10V$</td> <td>4.7m$\Omega$</td> </tr> <tr> <td>$I_D$</td> <td>140A</td> </tr> </table> <p>Pin Configuration</p> <div style="display: flex; justify-content: space-around; align-items: center;"> <div style="text-align: center;">  <p>TO-220C</p> </div> <div style="text-align: center;">  <p>Schematic</p> </div> </div>	V_{DSS}	100V	$R_{DS(on),max}@V_{GS}=10V$	4.7m Ω	I_D	140A
V_{DSS}	100V						
$R_{DS(on),max}@V_{GS}=10V$	4.7m Ω						
I_D	140A						

Absolute Maximum Ratings $T_C = 25^\circ C$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	100	V
Continuous drain current ($T_C = 25^\circ C$) ($T_C = 100^\circ C$)	I_D	140	A
		88	A
Pulsed drain current ¹⁾	I_{DM}	480	A
Gate-Source voltage	V_{GSS}	± 20	V
Avalanche energy ²⁾	E_{AS}	272	mJ
Power Dissipation	P_D	156	W
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ C$
Operating Junction Temperature Range	T_J	-55 to +150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.8	$^\circ C/W$
Thermal Resistance, Junction-to-Ambient ³⁾	$R_{\theta JA}$	75	$^\circ C/W$

Package Marking and Ordering Information

Device	Device Package	Marking	Units/Tube
VST10N047-TC	TO-220C	VST10N047-TC	50

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0\text{ V}, I_D=250\mu\text{A}$	100	---	---	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.0	---	4.0	V
Drain-source leakage current	I_{DSS}	$V_{DS}=100\text{ V}, V_{GS}=0\text{ V}, T_J = 25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=100\text{V}, V_{GS}=0\text{ V}, T_J = 150^\circ\text{C}$	---	---	100	μA
Gate leakage current, Forward	I_{GSSF}	$V_{GS}=20\text{ V}, V_{DS}=0\text{ V}$	---	---	100	nA
Gate leakage current, Reverse	I_{GSSR}	$V_{GS}=-20\text{V}, V_{DS}=0\text{ V}$	---	---	-100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=10\text{ V}, I_D=40\text{ A}, T_J = 25^\circ\text{C}$	---	4.2	4.7	m Ω
		$T_J = 150^\circ\text{C}$	---	7.8	---	
Forward transconductance	g_{fs}	$V_{DS} = 20\text{V}, I_D=40\text{A}$	---	120	---	S
Dynamic characteristics						
Input capacitance	C_{iss}	$V_{DS} = 50\text{V}, V_{GS} = 0\text{ V}, f = 250\text{kHz}$	---	3838	---	pF
Output capacitance	C_{oss}		---	1252	---	
Reverse transfer capacitance	C_{rss}		---	13.4	---	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 40\text{V}, V_{GS}=15\text{V}, I_D = 60\text{ A}$	---	29.4	---	ns
Rise time	t_r		---	29.2	---	
Turn-off delay time	$t_{d(off)}$		---	80.2	---	
Fall time	t_f		---	30.8	---	
Gate resistance	R_g	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	---	2.0	---	Ω
Gate charge characteristics						
Gate to source charge	Q_{gs}	$V_{DS}=80\text{ V}, I_D=80\text{A}, V_{GS}= 10\text{ V}$	---	20.5	---	nC
Gate to drain charge	Q_{gd}		---	16	---	
Gate charge total	Q_g		---	65	---	
Gate plateau voltage	$V_{plateau}$		---	5.5	---	V
Output Charge	Q_{oss}	$V_{DS}=80\text{ V}, V_{GS}= 0\text{V}$	---	138	---	nC
Drain-Source diode characteristics and Maximum Ratings						
Continuous Source Current	I_S		---	---	111	A
Pulsed Source Current	I_{SM}		---	---	444	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0\text{V}, I_S=80\text{A}, T_J=25^\circ\text{C}$	---	---	1.4	V
Reverse Recovery Time	t_{rr}	$I_S=80\text{A}, di/dt=100\text{A}/\mu\text{s}, T_J=25^\circ\text{C}$	---	55.6	---	ns
Reverse Recovery Charge	Q_{rr}		---	233	---	nC

Notes:

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2: $V_{DD}=50\text{V}, V_{GS}=10\text{V}, L=0.5\text{mH}, I_{AS}=33\text{A}, R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$.
- 3: The value of R_{thJA} is measured by placing the device in a still air box which is one cubic foot.

Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

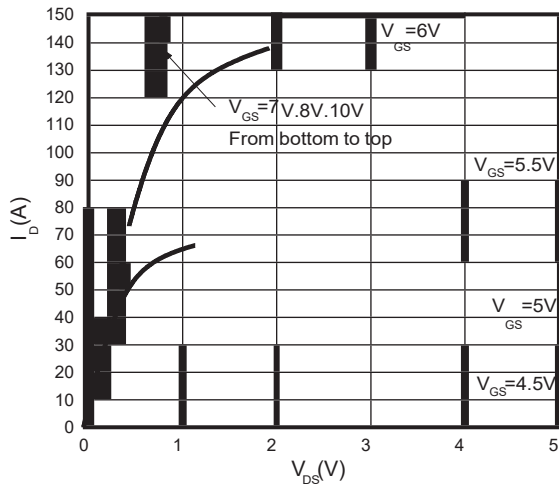


Figure 2. Transfer Characteristics

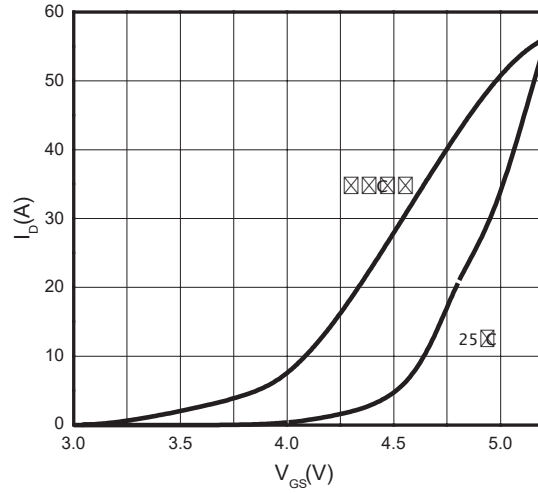


Figure 3. On-Resistance vs. Drain Current

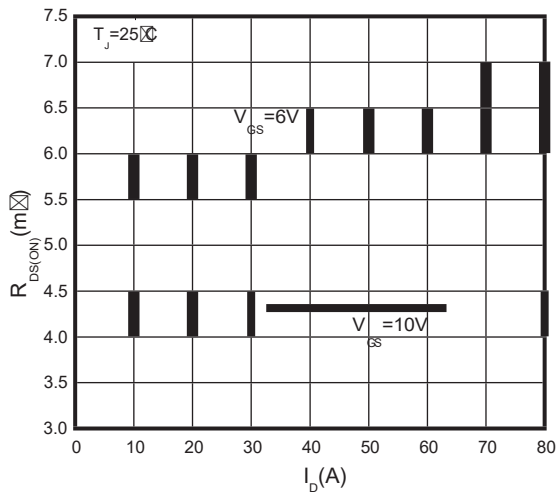


Figure 4. On-Resistance vs. Temperature

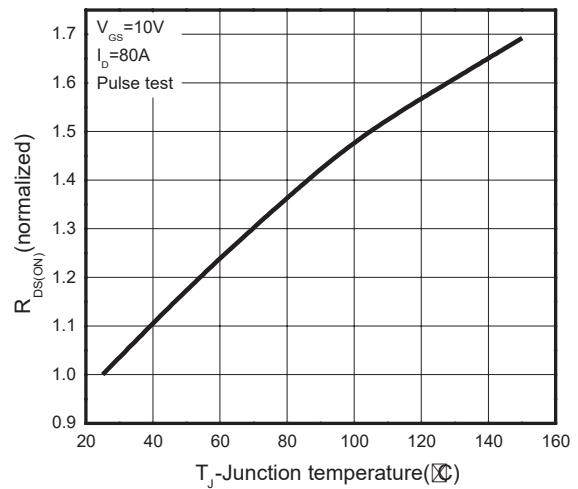


Figure 5. Breakdown Voltage vs. Temperature

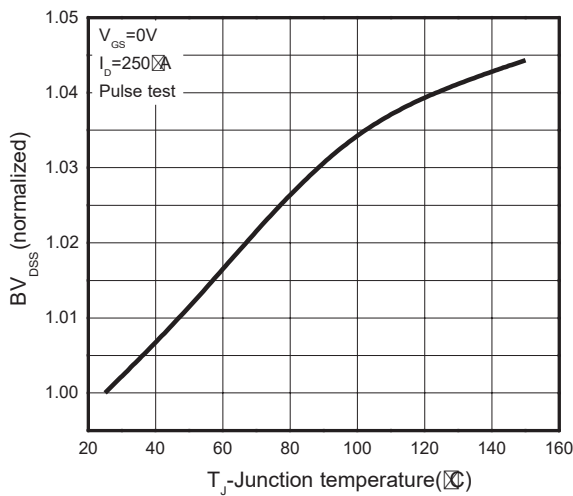


Figure 6. Threshold Voltage vs. Temperature

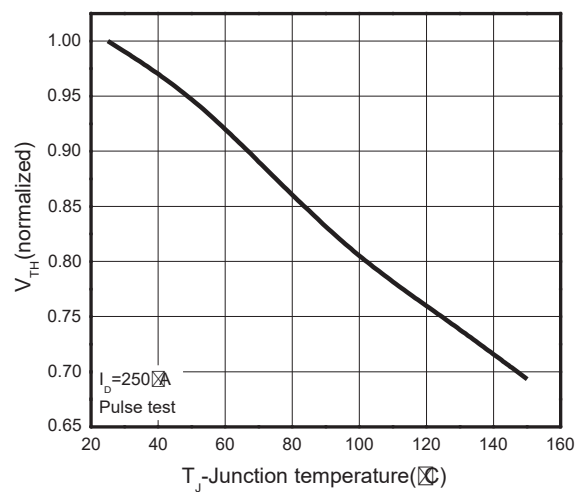


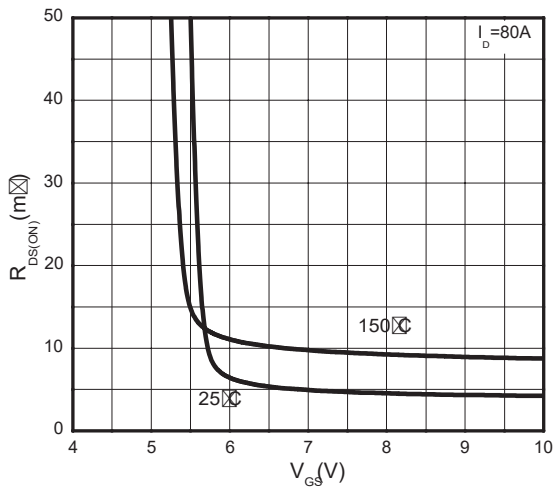
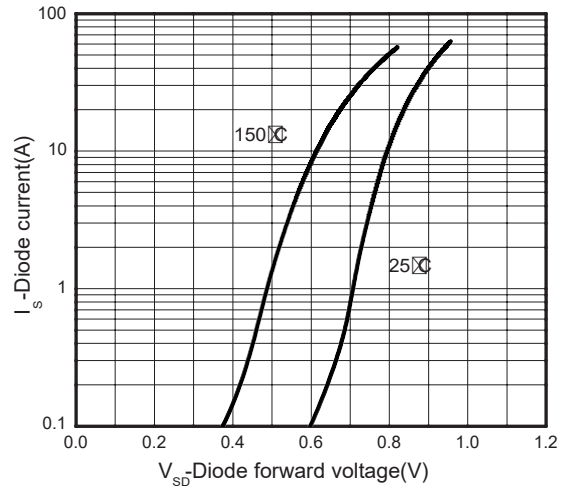
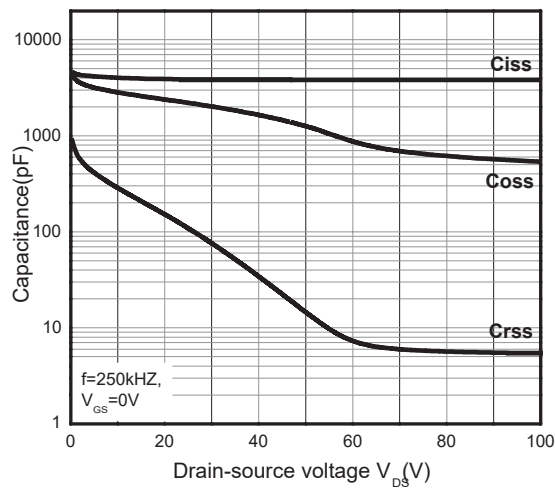
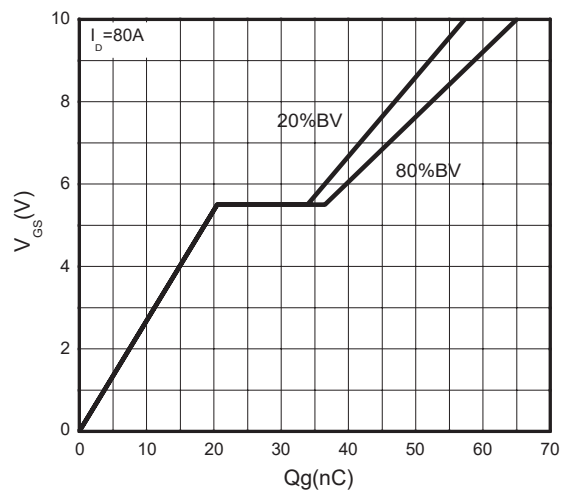
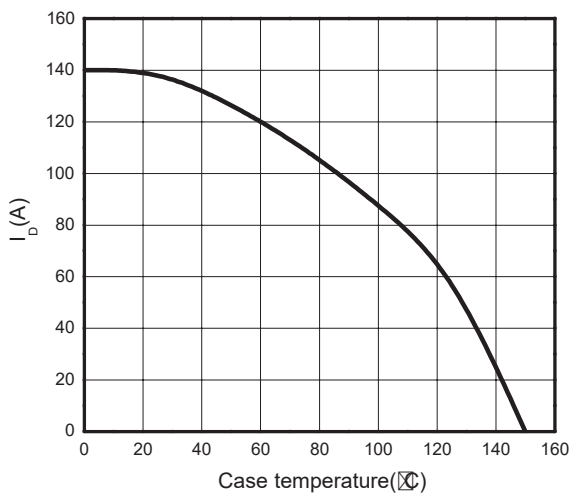
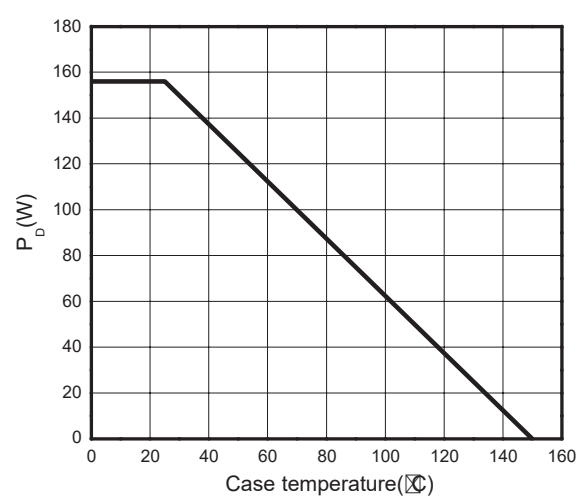
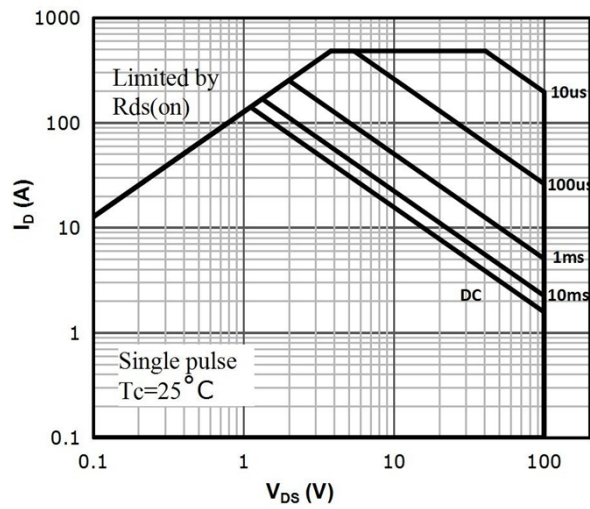
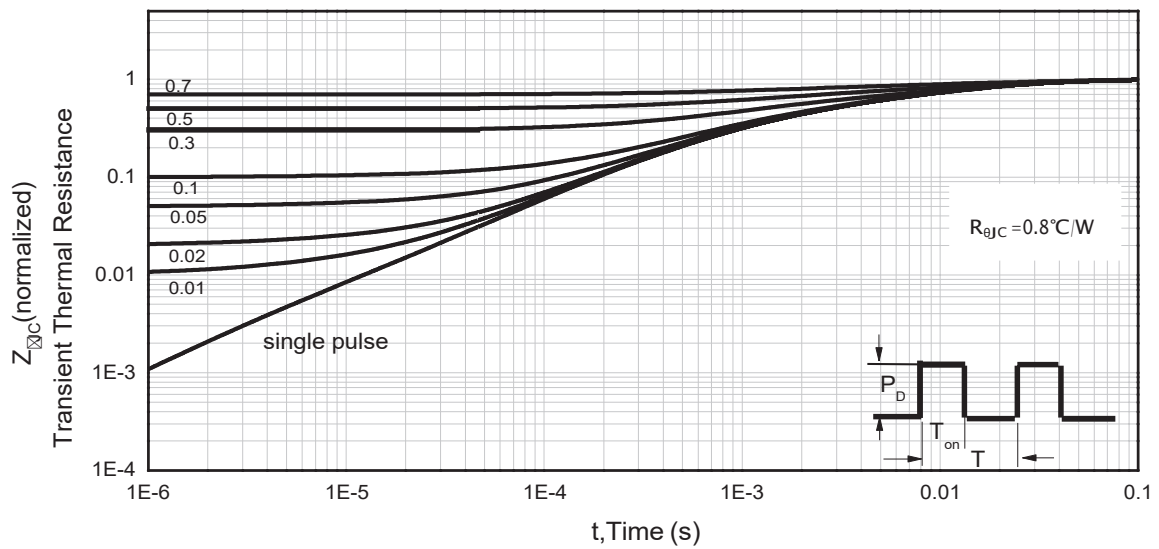
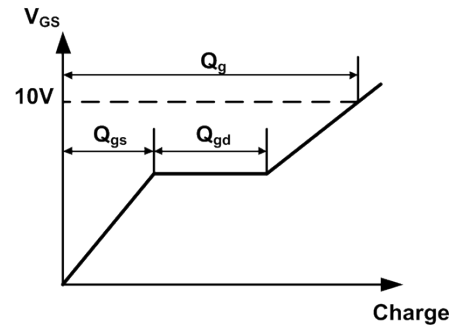
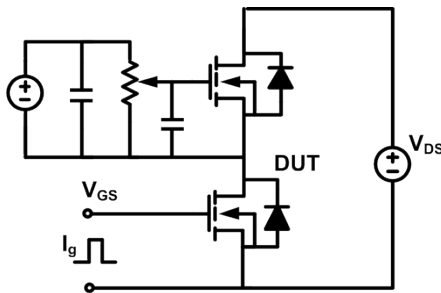
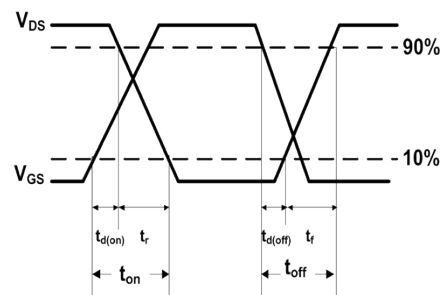
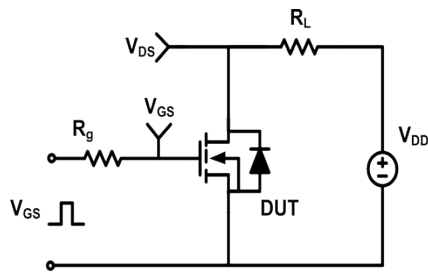
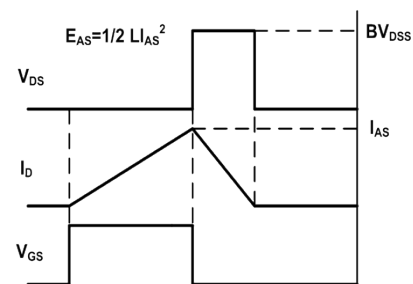
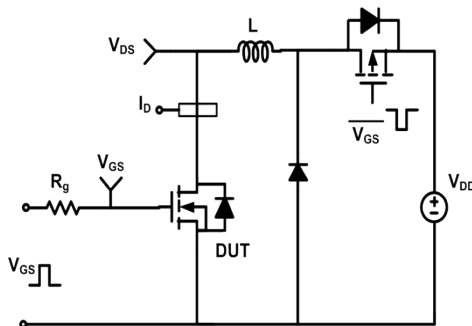
Figure 7. R_{DS(on)} vs. Gate Voltage

Figure 8. Body-Diode Characteristics

Figure 9. Capacitance Characteristics

Figure 10. Gate Charge Characteristics

Figure 11. Drain Current Derating

Figure 12. Power Dissipation vs. Temperature


Figure 13: Safe Operating Area


 Figure 14. Normalized Maximum Transient Thermal Impedance (R_{thJC})


Test Circuit & Waveforms
Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveform

Unclamped Inductive Switching (UIS) Test Circuit & Waveform

Diode Recovery Test Circuit & Waveform
